

SG901-1203 Intelligent Wi-Fi Module

Overview

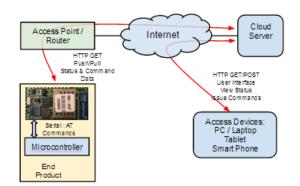
The SG901-1203 intelligent Wi-Fi Module is a standalone 802.11 b/g/n web content solution. With low power consumption and small form factor, the SG901-1203 is ideal for fixed and mobile wireless applications; especially challenging battery operated applications that can leverage the SG901-1203's 200 uA sleep current mode.

The SG901-1203 provides the full TCP/IP stack enabling end products to leverage AT Commands for wireless internet connectivity. Configured around a single-chip 802.11 transceiver, 32-bit microcontroller with extensive GPIO suite, 4Mb Program Flash, 8Mb Flash, and 64KB RAM, the SG901-1203 enables easy integration of wireless web access into exiting or new products with minimal software development.

The module is housed in a 28-pin LGA and incorporates required timing clocks and voltage regulators. The module is available with either an embedded micro 2.45GHz ISM band antenna, or u.FL connector for external antenna connection; as well as commercial and industrial temperature ranges.

Applications

- Deeply embedded wireless
- Home/Industrial automation
- · Wireless remote sensors
- iPad/Android remote control



Features

- 2.4GHz IEEE 802.11 b/g/n transceiver FCC/CE/IC certified
- 26.92 x 15.24 x 2.35 mm small form factor
- 200 uA sleep, 125 mA Rx, 330 mA Tx ultralow power consumption
- Embedded and u.FL configurations
- 8Mb flash memory
- 4Mb program flash memory
- 64KB RAM
- Real-time clock
- 3.3V regulated power supply operation
- · Ad hoc and infrastructure modes
- WEP, WPA, WPA2, WPA2 Enterprise support
- TCP/IP stack based on IwIP
- Simple AT command set with Over-the-Air FW update capability
- Web Server/client
- DHCP/DNS client
- HTTP client
- Web server
- RoHS compliant

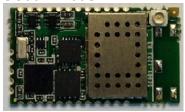
Supporting Documents

- SG922-0006 EVK User's Guide
- SG914-0040 EVK Datasheet
- SG922-0007 AT Command Set
- SG922-0008 FW Update Procedure

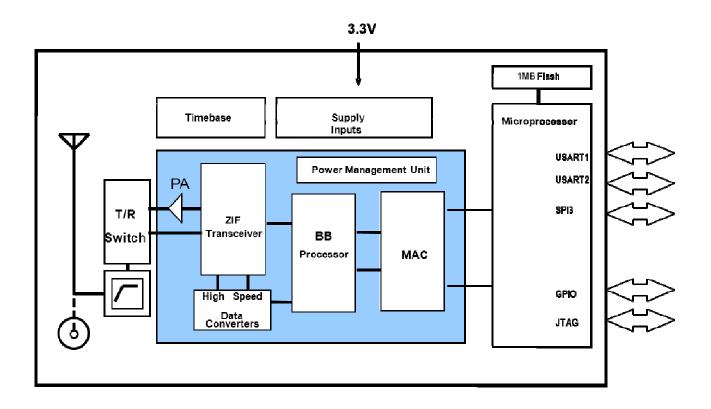
SG901-1203



SG901-1203U







Certifications

		Comment
FCC ID	VRA-SG9011203	On board antenna and external SG901-1066 with connector versions
IC ID	7420A-SG9011203	On board antenna and external SG901-1066 with connector versions
ETSI	Compliant	Approved with on board antenna and connector versions

Note: Sagrad SG901-1066 is the only approved antenna using the UFL connector version of the SG923-0011

Ordering Information

Description	Order Number	Notes		
Commercial temperature range module	SG901-1203-CT	0° to 70°C		
with embedded antenna configuration		Packaging: Cut tape/TR		
Industrial temperature range module with	SG901-1203-ET	-40° to 85°C		
embedded antenna configuration	3G901-1203-L1	Packaging: Cut tape/TR		
Commercial temperature range module	SG901-1203u-CT	0° to 70°C		
with u.FL antenna configuration	30901-1203u-C1	Packaging: Cut tape/TR		
Industrial temperature range module with	SG901-1203u-ET	-40° to 85°C		
u.FL antenna configuration	3G901-1203u-L1	Packaging: Cut tape/TR		
SG901-1203 EVK	SG923-0011			
Note: For orders less than 500 units, Sagrad ships in cut tape, otherwise Tape and Reel (TR) packaging is used.				

1-800-779-7139 WWW.SAGRAD.COM DOC#: SG914-0039 rev. 1.10



General Electrical Specifications (Typical results are at room temperature only

for all specifications)

Parameter		Test Condition / Comment	Min.	Тур.	Max.	Units	
Absolute Maximum Ratings							
3.3V Supply			-0.3		4.0	٧	
Vin for 5V tolerant p	ins		-0.3		5.5	V	
Vin for all other pins	1		-0.3		2.8	V	
Operating Conditions and Input Power Specifications							
O	B	Commercial	0		70	°C	
Operating Temperature Range		Extended Temperature	-40		85	°C	
3.3V Supply	Input Supply Voltage	3.3V Supply input	3.1	3.3	3.6	V	
	Power Save Mode Current	100mS beacon period, 75 byte beacons @ 1Mbps, short Preamble, DTIM = 3		20		mA	
	Sleep Current	3.3V 25°C, no data retention, wakeup on events		200		uA	
	Active RX w/power save (Note1)	DTIM 1, All beacons Received, no active data (average value)		900		uA	
	Average TX Current	Peak, transmitting packets, 3.3V, 25°C		330		mA	
	Average RX Current	Peak, Receiving packets, 3.3V, 25°C		125		mA	

Note1: Calculated from measurements of each subsection

Digital Interface Specifications

Parameter		Test Condition / Comment	Min.	Тур.	Max.	Units	
Digital Interface Spec	Digital Interface Specifications, I/O pins						
Inputs	VIH		1.4			V	
	VIL		0.6			V	
Outputs	VOH	IOH = 4mA	1.8			V	
	VOL	IOL = 4mA			.4	V	
Programmable Pull Up or Down Resistors		When turned on	80		120	Kohms	



RF Characteristics

Parameter		Test Condition / Comment	Min.	Тур.	Max.	Units
	11b, 1Mbps			-96		dBm
	11b, 2 Mbps			-93		dBm
	11b, 5.5 Mbps			-91		dBm
	11b, 11 Mbps			-87		dBm
	11g, 9Mbps			-89.5		dBm
RX Sensitivity	11g, 18Mbps			-86		dBm
(note 2)	11g, 36Mbps			-80		dBm
	11g, 54Mbps			-74.5		dBm
	11n, MCS1, 13Mbps			-86.5		dBm
	11n, MCS3, 26Mbps			-81.5		dBm
	11n, MCS5, 52Mbps			-74		dBm
	11n, MCS7, 65Mbps			-71		dBm
Channel to Channel De-sensitivity	CH1 to 14	11g, 54Mbps 10% PER		1		dB
Maximum Input Signal	CH7	11g, 54Mbps		-20		dBm
	11Mbps			38		dBc
	9Mbps			20		dBc
Adjacent Channel Rejection	54Mbps			4		dBc
,,	MCS1			24		dBc
	MCS7			3		dBc
	11b, 1Mbps	@802.11b spectral mask		18.3		dBm
	11b, 11Mbps	(2002.11b Spectral mask		18.3		dBm
TX Output Power	11g, 9Mbps	@802.11g spectral mask		18.3		dBm
(Note 2)	11g, 54Mbps	EVM = -27dB, 4.5%		13.7		dBm
	802.11n MCS1	@802.11n spectral mask		18.3		dBm
	802.11n MCS7	EVM = -27dB		13.5		dBm
On Board Antenna Gain		Average		-1.2		dBi
External Antenna Gain		SG901-1066 average including cable loss		2.8		dBi

Note 2: Output Power and sensitivities are measured with a 50 ohms connection at the antenna port.



LGA Pin Out and Description

·							
SIGNAL NAME	PIN NUMBER	DESCRIPTION	NOTES				
GPIO Pins and alternate SPI functions							
GPIO0_MISO	16	Alternate SPI MISO pin. Pull High on power up to reset settings	Input pull down and 5V tolerant				
GPIO1_MOSI	17	Alternate SPI MOSI	Input pull down and 5V tolerant				
GPIO2_SPICS	19	Alternate SPI Chip Select	Floating and 5V tolerant				
GPIO3_SCLK	1	Alternate SPI Clock	Input pull down and 5V tolerant				
GPIO6_ADC0	22	Wake Up/Sleep Inhibit	Input pull down and 5V tolerant				
Reserved Pins for future use							
GPIO4_RXD3	18						
GPIO5_TXD3	20						
GPIO7_ADC1	13						
GPIO8_ADC2	4						
GPIO9_ADC3	7						
GPIO11_SCL	11						
GPIO12_SDA	12						
GPIO15_DAC	21						
	Monitoring	purpose with no alternate function	1				
GPIO10	5	LED drive, Blinking while run					
GPIO13	15	LED drive, WIFI Link					
GPIO14	14	LED drive, Power up					
	,	UART Pins					
RXD1	8	UART Receive data input	5V tolerant				
TXD1	6	UART Transmit data output	5V tolerant				
CTS1_DN	9	UART Clear to Send input	Active low, 5V tolerant				
RTS1_DP	10	UART Request to send output	Active low, 5V tolerant				
		RESET					
RESETn	3	Reset input (See firmware load description)	Active low for 5ms with pull up to 2.5VDC. Not 5V tolerant.				
		JTAG Test Pins (NOTE)					
TRST_MISO3	28	JTAG TRST_N, Used for 1M Flash	5V tolerant				
TDI	27	JTAG TDI	5V tolerant				
TMS	26	JTAG TMS	5V tolerant				
TCK	29	JTAG TCK	5V tolerant				
TDO_SCK3	30	JTAG TDO, Used for 1M Flash	5V tolerant				
SUPPLY Pins and paddle							
3.3V	24	Voltage supply	Decouple with 10uF capacitor				
Ground	23	Ground					
Ground Paddle (NOTE)	25	Ground	Add plenty of ground vias for thermal dissipation and ground return				
	l F	I Firmware load Pin access	alssipation and ground return				
воото	2	(See firmware load description)					
			•				

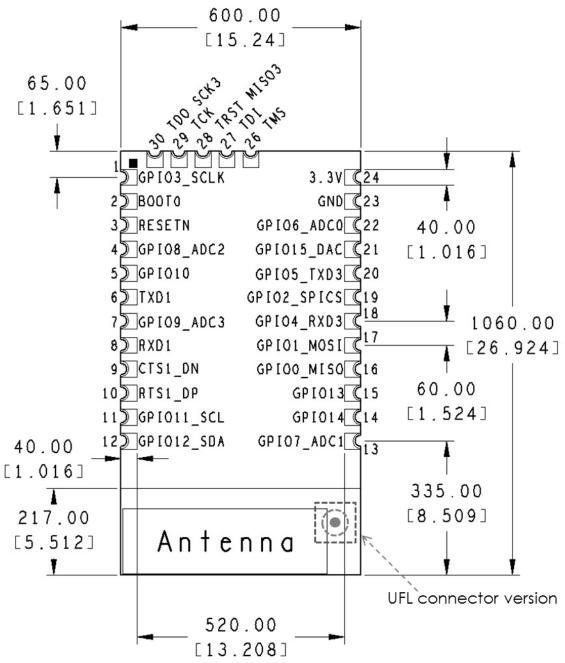
NOTE: Pins 26 to 30 and the Module Paddle, labeled Pin 25 are additional pins when compared to available Bluetooth Modules in the market.

NOTE: To enable the firmware download, Pin BOOT0 needs to be high during power up. RESETn pin need to be pulled low at least 5ms to initiate the firmware download sequence. The latest firmware is available at www.sagrad.com for download. Please refer to SG922-0008 document for full description



Top View

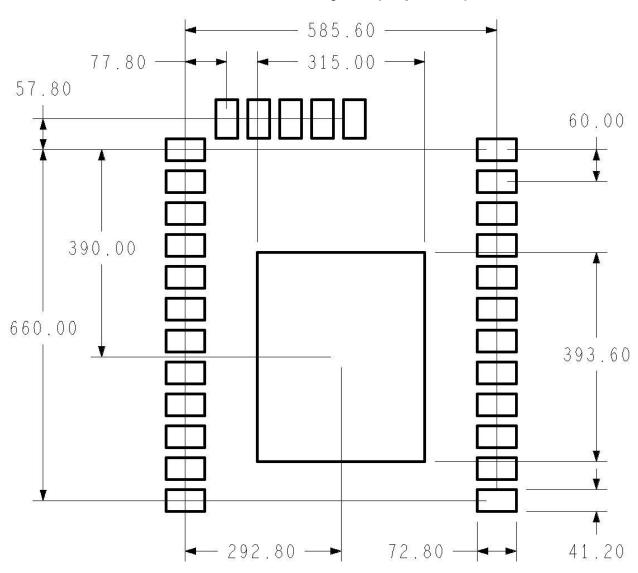
Dimensions: L: 26.92mm W: 15.24mm H: 2.35mm



NOTE: An antenna area of 217X520 mils need to be free of any ground metallization or traces under the unit. The area extending away from the antenna should be free from metal on the PCB and housing to meet expected performance. Pin 25 is the required paddle ground and is not shown in this diagram.



Recommended Layout (Top View)



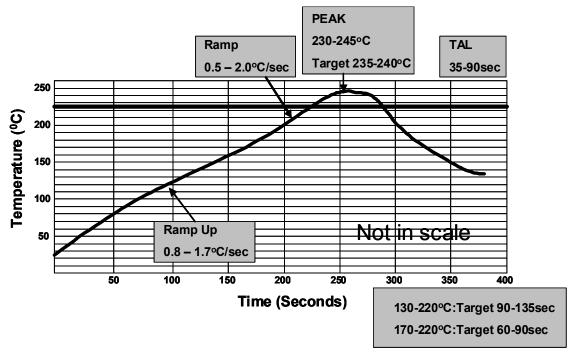
PCB design requires detailed review of center exposed pad. This pad requires good thermal conductivity. Soldering coverage should be maximized and checked via x-ray for proper design. There is a trade off in providing enough soldering for conductivity and too much which allows the module to "float" on the paddle creating reliability issues. Sagrad recommends two approaches, a large center via that allows excess soldering to flow down into the host PCB with smaller vias arount it. Or many smaller vias with just enough space for the viscosity of the chosen solder/flux to allow some solder to flow into the smaller vias. Each of these approaches need to result in 60% or more full contact solder coverage on the paddle after reflow. Sagrad strongly encourages PCB layout teams to work with their EMS providers to ensure vias and solder paste designs will result in satisfactory performance.

Note: Pin 1 is on the top left corner of this diagram. See note on the Top View Pin out for antenna to PCB interference requirements for the layout.



Mechanical

- Maximum Peak Reflow Temperature: 240°C
- Recommended Reflow Profile:



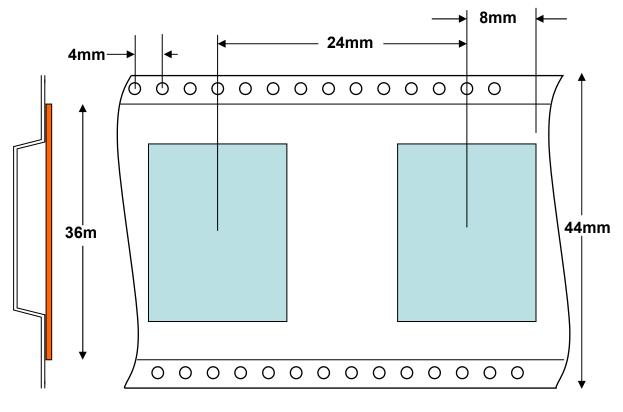
Moisture Level Sensitivity: 3

Limiting component for moisture is the PCB used in the module.



Packaging

The part comes packaged in Tape and Reel



Cover Tape

Media



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